


## APPLICATION DATA SHEET

Electronic Version v14

Stylesheet Version v14.0

<b>Title of Invention</b>	Power Controlled Interleave-division Multiple-access Wireless Communication Systems		
<b>Application Type :</b> regular, utility			
Correspondence address:			
Customer Number:		41559	
<b>Inventors Information:</b>			
<u>Inventor 1:</u>			
<b>Applicant Authority Type:</b>	Inventor		
<b>Citizenship:</b>	AU		
<b>Name prefix:</b>	Dr.		
<b>Given Name:</b>	Ping		
<b>Family Name:</b>	Li		
<b>Residence:</b>			
<b>City of Residence:</b>	Hong Kong		
<b>Country of Residence:</b>	CN		
<b>Address-1 of Mailing Address:</b>	City University of Hong Kong		
<b>Address-2 of Mailing Address:</b>	Department of Electronic Engineering		
<b>City of Mailing Address:</b>	Hong Kong		
<b>State of Mailing Address:</b>			
<b>Postal Code of Mailing Address:</b>			
<b>Country of Mailing Address:</b>	CN		
<b>Phone:</b>	+852 2788 9574		
<b>Fax:</b>	+852 2788 7791		
<b>E-mail:</b>	eeliping@cityu.edu.hk		
<u>Inventor 2:</u>			
<b>Applicant Authority Type:</b>	Inventor		
<b>Citizenship:</b>	AU		
<b>Name prefix:</b>	Dr.		
<b>Given Name:</b>	Sammy		
<b>Family Name:</b>	Chan		
<b>Residence:</b>			

<b>City of Residence:</b>	Hong Kong
<b>Country of Residence:</b>	CN
<b>Address-1 of Mailing Address:</b>	City University of Hong Kong
<b>Address-2 of Mailing Address:</b>	Department of Electronic Engineering
<b>City of Mailing Address:</b>	Hong Kong
<b>State of Mailing Address:</b>	
<b>Postal Code of Mailing Address:</b>	
<b>Country of Mailing Address:</b>	CN
<b>Phone:</b>	+852 2788 7781
<b>Fax:</b>	+852 2788 7791
<b>E-mail:</b>	schan@ee.cityu.edu.hk